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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tomoyo Ooyama	02/26/2008
Yukifumi Takeda	02/26/2008
Masanori Soma	02/26/2008
Hideki Nakai	02/26/2008

RECEIVING PARTY DATA

Name:	Sony Corporation
Street Address:	1-7-1 Konan, Minato-ku
City:	Tokyo
State/Country:	JAPAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12059939

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Thomas C. Basso

112857-1276

Total Attachments: 2

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ATTORNEY DOCKET NUMBER:

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REEL: 020781 FRAME: 0416

PATENT

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PATENT REEL: 020781 FRAME: 0417

Docket	Number:		
Docker	Number:	 	

ASSIGNM	ENT
WHEREAS, I, as a below named inventor, residing only one name is listed below) or a joint inventor (if plural names a	g at the address stated next to my name, am a sole inventor (if re listed below) of certain new and useful improvements in
for which application for Letters Patent of the United States of Amerand address;	ica was executed by me on the date indicated next to my name
AND WHEREAS, Sony Corporation, a Japanes Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of ac said application disclosing the invention and in, to and under any L therefor in the United States and in any and all foreign countries;	e corporation with offices at 1-7-1 Konan, Minato-Ku, quiring all interest in, to and under said invention, etters Patent or similar legal protection which may be granted
NOW THEREFORE, in consideration of the sum of the receipt and sufficience of which are hereby acknowledged, I, as a hereby assign, sell and transfer unto the said ASSIGNEE, its success interest in the said invention, said application, including any division Patent of the United States, and countries foreign thereto, which may rights and/or convention rights under the International Convention for a Relating to Patents, Designs and Industrial Models, and any other in adheres, and to any other benefits accruing or to accrue to me with patents in the United States and countries foreign thereto, and I hereby said United States Letters Patent to said ASSIGNEE, as the assignee	ors, assigns, and legal representatives, the entire right, title and ins and continuations thereof, and in and to any and all Letters be granted for said invention, and in and to any and all priority the Protection of Industrial Property, Inter-American Convention international agreements to which the United States of America respect to the filing of applications for patents or securing of authorize and request the Commissioner of Patents to issue the
And I further agree to execute all necessary or desirable ar ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and without further remuneration, in order to perfect title in said i applications and Letters Patent of the United States and countries for	nvention, modifications, and improvements in said invention,
And I further agree to properly execute and deliver and without papers for application for foreign patents, for filing subdivisions of reissues of any Letters Patent which may be granted for my aforesaid prepare at its own expense;	out further remuneration, such necessary or desirable and lawful said application for patent, and or, for obtaining any reissue or invention, as the ASSIGNEE thereof shall hereafter require and
And I further agree that ASSIGNEE will, upon its request, relating to said application, said invention and said Letters Patent ar accessible to me and will testify as to the same in any interference of	, be provided promptly with all pertinent facts and documents and legal equivalents in foreign countries as may be known and or litigation related thereto;
And I hereby covenant that no assignment, sale, agreement awould conflict with this assignment and sale.	or encumbrance has been or will be made or entered into which
And I hereby authorize and request my attorney(s) of record this application in the spaces that follow: Serial Number: $12/059$,	in this application to insert the serial number and filing date of 939 Filing Date March 31, 2008
This assignment executed on the dates indicated below.	
Tomoyo OOYAMA	26- Feb-2008
Name of first or sole inventor	Execution date of U.S. Patent Application
Fukushima, Japan	
Residence of first or sole inventor	
Tomoyo Ooyania	26 - Feb - 2008
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 020781 FRAME: 0418

Yukifumi TAKEDA	46-7ch200 k.
Name of second inventor	Execution date of U.S. Patent Application
Fukushima, Japan	
Residence of second inventor	
Signature of second inventor	26- Feb. 2008 Date of this assignment
Masanori SOMA	26 Feb 2008
Name of third inventor	Execution date of U.S. Patent Application
Fukushima, Japan	
Residence of third inventor	
Masanori Soma	26. Feb 2008
Signature of third inventor	Date of this assignment
Hideki NAKAI	26. Feb. 2008
Name of fourth inventor	Execution date of U.S. Patent Application
Fukushima, Japan	
Residence of fourth inventor	
(Lideki napar	26. feb. 2008
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

PATENT REEL: 020781 FRAME: 0419

RECORDED: 04/10/2008